

8M x 36-Bit Dynamic RAM Module

HYM 368020S/GS-60/-70

Advanced Information

- 8 388 608 words by 36-bit organization (alternative 16 777 216 words by 18-bit)
- Fast access and cycle time
 - 60 ns access time
 - 110 ns cycle time (-60 version)
 - 70 ns access time
 - 130 ns cycle time (-70 version)
- Fast page mode capability
 - 40 ns cycle time (-60 version)
 - 45 ns cycle time (-70 version)
- Single + 5 V ($\pm 10\%$) supply
- Low power dissipation
 - max. 7260 mW active (-60 version)
 - max. 6600 mW active (-70 version)
 - CMOS – 132 mW standby
 - TTL – 264 mW standby
- $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - $\overline{\text{RAS}}$ -only-refresh
 - Hidden-refresh
- 24 decoupling capacitors mounted on substrate
- All inputs, outputs and clocks fully TTL compatible
- 72 pin Single in-Line Memory Module (L-SIM-72-14) with 31.75 mm height
- Utilizes sixteen 4M x 4-DRAMs and eight 4M x 1 DRAMs in 300 mil wide SOJ packages
- 2048 refresh cycles / 32 ms
- Optimized for use in byte-write parity applications
- Tin-Lead contact pads (S- version)
- Gold contact pads (GS - version)

The HYM 368020S/GS-60/-70 is a 32 MByte DRAM module organized as 8 388 608 words by 36-Bit in a 72-pin single-in-line package comprising sixteen HYB 5117400BJ 4M × 4 DRAMs and eight HYB 514100BJ 4M × 1 DRAMs in 300 mil wide SOJ-packages mounted together with 24 0.2 µF ceramic decoupling capacitors on a PC board.

The HYM 368020S/GS-60/-70 can also be used as a 16 777 360 words by 18-bits dynamic RAM module by means of connecting DQ0 and DQ18, DQ1 and DQ19, DQ2 and DQ20, ..., DQ17 and DQ35, respectively.

Each HYB 5117400BJ and HYB 514100BJ is described in the data sheet and is fully electrical tested and processed according to SIEMENS standard quality procedure prior to module assembly. After assembly onto the board, a further set of electrical tests is performed.

The speed of the module can be detected by the use of four presence detect pins.

The common I/O feature on the HYM 368020S/GS-60/-70 dictates the use of early write cycles.

Ordering Information

Type	Ordering Code	Package	Description
HYM 368020S-60	Q67100-Q985	L-SIM-72-14	DRAM Module (access time 60 ns)
HYM 368020S-70	Q67100-Q986	L-SIM-72-14	DRAM Module (access time 70 ns)
HYM 368020GS-60	Q67100-Q2007	L-SIM-72-14	DRAM Module (access time 60 ns)
HYM 368020GS-70	on request	L-SIM-72-14	DRAM Module (access time 70 ns)

Pin Configuration (top view)

V_{SS} 1 DQ0 2
 DQ18 3 DQ1 4
 DQ19 5 DQ2 6
 DQ20 7 DQ3 8
 DQ21 9 V_{CC} 10
 N.C. 11 A0 12
 A1 13 A2 14
 A3 15 A4 16
 A5 17 A6 18
 A10 19 DQ4 20
 DQ22 21 DQ5 22
 DQ23 23 DQ6 24
 DQ24 25 DQ7 26
 DQ25 27 A7 28
 N.C. 29 V_{CC} 30
 A8 31 A9 32
 $\overline{RAS3}$ 33 $\overline{RAS2}$ 34
 DQ26 35 DQ8 36

DQ17 37 DQ35 38
 V_{SS} 39 $\overline{CAS0}$ 40
 $\overline{CAS2}$ 41 $\overline{CAS3}$ 42
 $\overline{CAS1}$ 43 $\overline{RAS0}$ 44
 $\overline{RAS1}$ 45 N.C. 46
 WE 47 N.C. 48
 DQ9 49 DQ27 50
 DQ10 51 DQ28 52
 DQ11 53 DQ29 54
 DQ12 55 DQ30 56
 DQ13 57 DQ31 58
 V_{CC} 59 DQ32 60
 DQ14 61 DQ33 62
 DQ15 63 DQ34 64
 DQ16 65 N.C. 66
 PD0 67 PD1 68
 PD2 69 PD3 70
 N.C. 71 V_{SS} 72

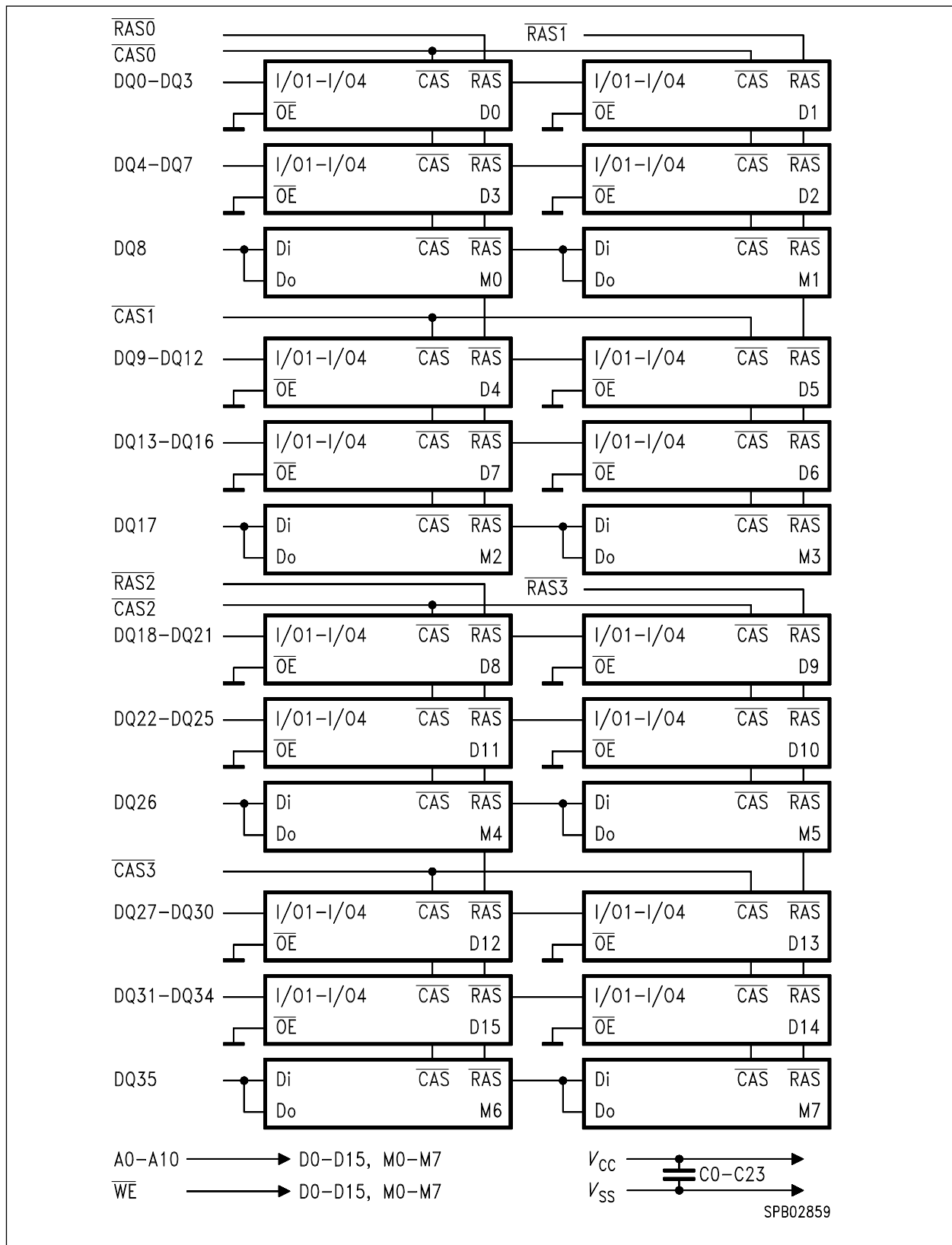
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Pin Names

A0-A10	Address Inputs
DQ0-DQ35	Data Input/Output
$\overline{CAS0}$ - $\overline{CAS3}$	Column Address Strobe
$\overline{RAS0}$ - $\overline{RAS3}$	Row Address Strobe
WE	Read/Write Input
V_{CC}	Power (+ 5 V)
V_{SS}	Ground
PD	Presence Detect Pin
N.C.	No Connection

Presence Detect Pins

	-60	-70
PD0	N.C.	N.C.
PD1	V_{SS}	V_{SS}
PD2	N.C.	V_{SS}
PD3	N.C.	N.C.



Block Diagram

Absolute Maximum Ratings

Operation temperature range 0 to + 70 °C
 Storage temperature range..... – 55 to 125 °C
 Input/output voltage – 0.5 V to min ($V_{CC} + 0.5$, 7.0) V
 Power supply voltage..... – 1 to + 7 V
 Power dissipation..... 9.24 W
 Data out current (short circuit) 50 mA

Note: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage of the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC Characteristics

$T_A = 0$ to 70 °C, $V_{CC} = 5$ V $\pm$ 10 %

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Input high voltage	V_{IH}	2.4	$V_{CC} + 0.5$	V	1)
Input low voltage	V_{IL}	– 0.5	0.8	V	1)
Output high voltage ($I_{OUT} = -5$ mA)	V_{OH}	2.4	–	V	1)
Output low voltage ($I_{OUT} = 4.2$ mA)	V_{OL}	–	0.4	V	1)
Input leakage current (0 V < V_{IN} < 6.5 V, all other pins = 0 V)	$I_{I(L)}$	– 20	20	μA	1)
Output leakage current (DO is disabled, 0 V < V_{OUT} < 5.5 V)	$I_{O(L)}$	– 20	20	μA	1)
Average V_{CC} supply current (RAS, CAS, address cycling, $t_{RC} = t_{RC\ min}$) –60 version –70 version	I_{CC1}	– –	1320 1200	mA mA	2),3),4)
Standby V_{CC} supply current ($\overline{RAS} = \overline{CAS} = V_{IH}$)	I_{CC2}	–	48	mA	
Average V_{CC} supply current during RAS only refresh cycles (RAS cycling, $\overline{CAS} = V_{IH}$, $t_{RC} = t_{RC\ min}$) –60 version –70 version	I_{CC3}	– –	1320 1200	mA mA	2),4)

DC Characteristics¹⁾ (cont'd)

Parameter	Symbol	Limit Values		Unit	Test Condition
		min.	max.		
Average V_{CC} supply current during fast page mode ($\overline{RAS} = V_{IL}$, $\overline{CAS}$, address cycling, $t_{PC} = t_{PC \min}$) -60 version -70 version	I_{CC4}	— —	920 840	mA mA	2),3),4)
Standby V_{CC} supply current ($\overline{RAS} = \overline{CAS} = V_{CC} - 0.2 \text{ V}$)	I_{CC5}	—	24	mA	
Average V_{CC} supply current during $\overline{CAS}$ -before- $\overline{RAS}$ refresh mode ($\overline{RAS}$, $\overline{CAS}$ cycling, $t_{RC} = t_{RC \min}$) -60 version -70 version	I_{CC6}	— —	1320 1200	mA mA	2),4)

Capacitance

$T_A = 0 \text{ to } 70 \text{ }^\circ\text{C}$, $V_{CC} = 5 \text{ V} \pm 10 \%$, $f = 1 \text{ MHz}$

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Input capacitance (A0 to A10, $\overline{WE}$)	C_{I1}	—	180	pF
Input capacitance ($\overline{RAS0} - \overline{RAS3}$)	C_{I2}	—	50	pF
Input capacitance ($\overline{CAS0} - \overline{CAS3}$)	C_{I3}	—	40	pF
I/O capacitance (DQ0-DQ35)	C_{I0}	—	25	pF

AC Characteristics ⁵⁾⁶⁾

$T_A = 0 \text{ to } 70 \text{ }^\circ\text{C}$, $V_{CC} = 5 \text{ V} \pm 10 \%$, $t_T = 5 \text{ ns}$

Parameter	Symbol	Limit Values				Unit	Note
		-50		-60			
		min.	max.	min.	max.		

Common Parameters

Random read or write cycle time	t_{RC}	90	—	110	—	ns	
RAS precharge time	t_{RP}	30	—	40	—	ns	
RAS pulse width	t_{RAS}	50	10k	60	10k	ns	
CAS pulse width	t_{CAS}	13	10k	15	10k	ns	
Row address setup time	t_{ASR}	0	—	0	—	ns	
Row address hold time	t_{RAH}	8	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	ns	
Column address hold time	t_{CAH}	10	—	15	—	ns	
RAS to CAS delay time	t_{RCD}	18	37	20	45		
RAS to column address delay time	t_{RAD}	13	25	15	30	ns	
RAS hold time	t_{RSH}	13		15	—	ns	
CAS hold time	t_{CSH}	50		60	—	ns	
CAS to RAS precharge time	t_{CRP}	5	—	5	—	ns	
Transition time (rise and fall)	t_T	3	50	3	50	ns	7
Refresh period	t_{REF}	—	32	—	32	ms	

Read Cycle

Access time from RAS	t_{RAC}	—	50	—	60	ns	8, 9
Access time from CAS	t_{CAC}	—	13	—	15	ns	8, 9
Access time from column address	t_{AA}	—	25	—	30	ns	8,10
Column address to RAS lead time	t_{RAL}	25	—	30	—	ns	
Read command setup time	t_{RCS}	0	—	0	—	ns	
Read command hold time	t_{RCH}	0	—	0	—	ns	11
Read command hold time referenced to RAS	t_{RRH}	0	—	0	—	ns	11
CAS to output in low-Z	t_{CLZ}	0	—	0	—	ns	8
Output buffer turn-off delay	t_{OFF}	0	13	0	15	ns	12

AC Characteristics (cont'd) ⁵⁾⁶⁾

$T_A = 0 \text{ to } 70^\circ\text{C}$, $V_{CC} = 5 \text{ V} \pm 10\%$, $t_T = 5 \text{ ns}$

Parameter	Symbol	Limit Values				Unit	Note
		-50		-60			
		min.	max.	min.	max.		

Early Write Cycle

Write command hold time	t_{WCH}	8	—	10	—	ns	
Write command pulse width	t_{WP}	8	—	10	—	ns	
Write command setup time	t_{WCS}	0	—	0	—	ns	13
Write command to $\overline{\text{RAS}}$ lead time	t_{RWL}	13	—	15	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	t_{CWL}	13	—	15	—	ns	
Data setup time	t_{DS}	0	—	0	—	ns	14
Data hold time	t_{DH}	10	—	10	—	ns	14

Fast Page Mode Cycle

Fast page mode cycle time	t_{PC}	35	—	40	—	ns	
$\overline{\text{CAS}}$ precharge time	t_{CP}	10	—	10	—	ns	
Access time from $\overline{\text{CAS}}$ precharge	t_{CPA}	—	30	—	35	ns	7
$\overline{\text{RAS}}$ pulse width	t_{RAS}	50	200k	60	200k	ns	
$\overline{\text{CAS}}$ precharge to $\overline{\text{RAS}}$ Delay	t_{RHCP}	30	—	35	—	ns	

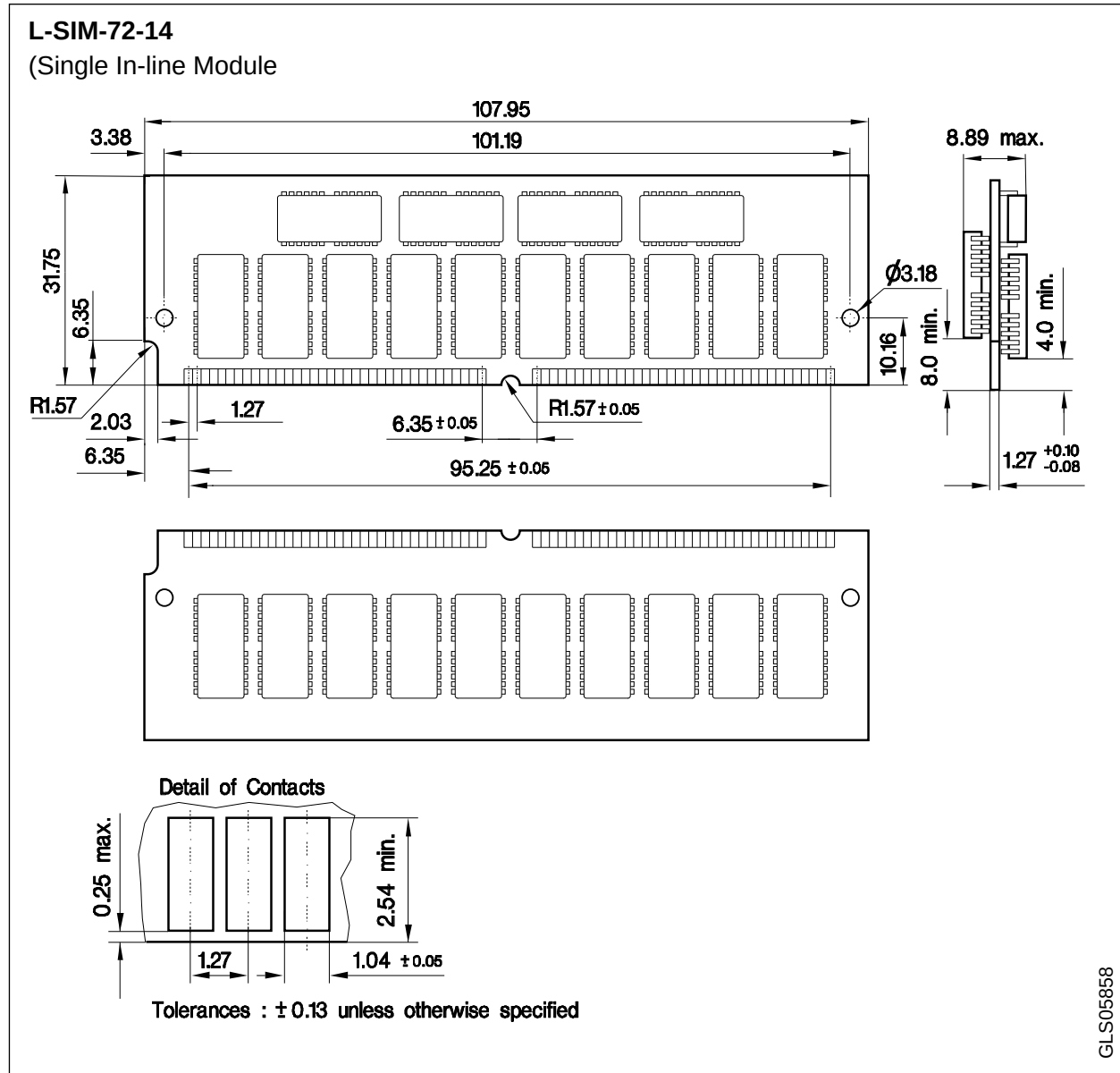
$\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ Refresh Cycle

$\overline{\text{CAS}}$ setup time	t_{CSR}	10	—	10	—	ns	
$\overline{\text{CAS}}$ hold time	t_{CHR}	10	—	10	—	ns	
$\overline{\text{RAS}}$ to $\overline{\text{CAS}}$ precharge time	t_{RPC}	5	—	5	—	ns	
Write to $\overline{\text{RAS}}$ precharge time	t_{WRP}	10	—	10	—	ns	
Write hold time referenced to $\overline{\text{RAS}}$	t_{WRH}	10	—	10	—	ns	

Notes:

- 1) All voltages are referenced to V_{SS} .
- 2) I_{CC1} , I_{CC3} , I_{CC4} and I_{CC6} depend on cycle rate.
- 3) I_{CC1} and I_{CC4} depend on output loading. Specified values are measured with the output open.
- 4) Address can be changed once or less while $\overline{RAS} = V_{IL}$. In the case of I_{CC4} it can be changed once or less during a fast page mode cycle (t_{PC}).
- 5) An initial pause of 200 μs is required after power-up followed by 8 $\overline{RAS}$ cycles of which at least one cycle has to be a refresh cycle, before proper device operation is achieved. In case of using internal refresh counter, a minimum of 8 CAS-before-RAS initialization cycles instead of 8 $\overline{RAS}$ cycles are required.
- 6) AC measurements assume $t_T = 5$ ns.
- 7) $V_{IH (min.)}$ and $V_{IL (max.)}$ are reference levels for measuring timing of input signals. Transition times are also measured between V_{IH} and V_{IL} .
- 8) Measured with a load equivalent to 2 TTL loads and 100 pF.
- 9) Operation within the $t_{RCD (max.)}$ limit ensures that $t_{RAC (max.)}$ can be met. $t_{RCD (max.)}$ is specified as a reference point only: If t_{RCD} is greater than the specified $t_{RCD (max.)}$ limit, then access time is controlled by t_{CAC} .
- 10) Operation within the $t_{RAD (max.)}$ limit ensures that $t_{RAC (max.)}$ can be met. $t_{RAD (max.)}$ is specified as a reference point only: If t_{RAD} is greater than the specified $t_{RAD (max.)}$ limit, then access time is controlled by t_{AA} .
- 11) Either t_{RCH} or t_{RRH} must be satisfied for a read cycle.
- 12) $t_{OFF (max.)}$ define the time at which the outputs achieve the open-circuit condition and are not referenced to output voltage levels.
- 13) t_{WCS} is not a restrictive operating parameter. This is included in the data sheet as electrical characteristics only. If $t_{WCS} > t_{WCS (min.)}$, the cycle is an early write cycle and the I/O pin will remain open-circuit (high impedance) through the entire cycle.
- 14) These parameters are referenced to the $\overline{CAS}$ leading edge.

Package Outline



Sorts of Packing

Package outlines for tubes, trays etc. are contained in our Data Book "Package Information".

SMD = Surface Mounted Device

Dimensions in mm